

MMFTN3420B

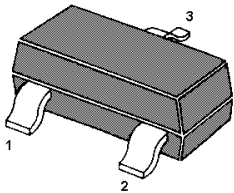
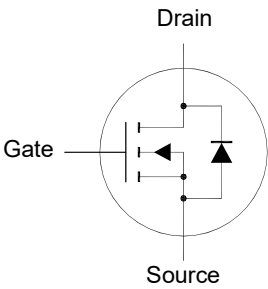
N-Channel Enhancement Mode MOSFET

Features

- Surface-mounted package

Applications

- Portable appliances
- Battery management



1. Gate 2. Source 3. Drain
SOT-23 Plastic Package

Absolute Maximum Ratings (at $T_a = 25^{\circ}\text{C}$ unless otherwise specified)

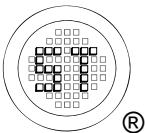
| Parameter | Symbol | Value | Unit |
|--|----------------|---------------|--------------------|
| Drain-Source Voltage | V_{DS} | 20 | V |
| Drain-Gate Voltage | V_{GS} | ± 12 | V |
| Drain Current | I_D | 6 | A |
| Peak Drain Current, Pulsed ¹⁾ | I_{DM} | 20 | A |
| Total Power Dissipation ²⁾ | P_{tot} | 740 | mW |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to + 150 | $^{\circ}\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Max. | Unit |
|---|-----------------|------|----------------------|
| Thermal Resistance from Junction to Ambient ²⁾ | $R_{\theta JA}$ | 167 | $^{\circ}\text{C/W}$ |

¹⁾ Pulse Test: Pulse Width $\leq 100 \mu\text{s}$, Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})} = 150^{\circ}\text{C}$.

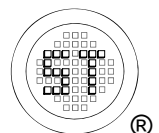
²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



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Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|---|--------------|------------------|------------------|----------------------|---------------|
| STATIC PARAMETERS | | | | | |
| Drain-Source Breakdown Voltage at $I_D = 250\ \mu\text{A}$ | BV_{DSS} | 20 | - | - | V |
| Drain-Source Leakage Current at $V_{DS} = 20\ \text{V}$ | I_{DSS} | - | - | 1 | μA |
| Gate-Source Leakage Current at $V_{GS} = \pm 12\ \text{V}$ | I_{GSS} | - | - | ± 100 | nA |
| Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$ | $V_{GS(th)}$ | 0.4 | - | 1.2 | V |
| Drain-Source On-State Resistance at $V_{GS} = 10\ \text{V}$, $I_D = 6\ \text{A}$ at $V_{GS} = 4.5\ \text{V}$, $I_D = 5\ \text{A}$ at $V_{GS} = 2.5\ \text{V}$, $I_D = 4\ \text{A}$ at $V_{GS} = 1.8\ \text{V}$, $I_D = 2\ \text{A}$ | $R_{DS(on)}$ | - - - - | - - - - | 29 35 48 91 | m Ω |
| DYNAMIC PARAMETERS | | | | | |
| Forward Transconductance at $V_{DS} = 5\ \text{V}$, $I_D = 4\ \text{A}$ | g_{fs} | - | 12.6 | - | S |
| Gate Resistance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 0\ \text{V}$, $f = 1\ \text{MHz}$ | R_g | - | 2.9 | - | Ω |
| Input Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 10\ \text{V}$, $f = 1\ \text{MHz}$ | C_{iss} | - | 871 | - | pF |
| Output Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 10\ \text{V}$, $f = 1\ \text{MHz}$ | C_{oss} | - | 117 | - | pF |
| Reverse Transfer Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 10\ \text{V}$, $f = 1\ \text{MHz}$ | C_{rss} | - | 87 | - | pF |
| Gate charge total at $V_{DS} = 10\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 6\ \text{A}$ at $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 6\ \text{A}$ | Q_g | - - | 21.2 9.6 | - - | nC |
| Gate to Source Charge at $V_{DS} = 10\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 6\ \text{A}$ | Q_{gs} | - | 2.2 | - | nC |
| Gate to Drain Charge at $V_{DS} = 10\ \text{V}$, $V_{GS} = 10\ \text{V}$, $I_D = 6\ \text{A}$ | Q_{gd} | - | 2.3 | - | nC |
| Turn-On Delay Time at $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 6\ \text{A}$, $R_g = 3.3\ \Omega$ | $t_{d(on)}$ | - | 14 | - | ns |
| Turn-On Rise Time at $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 6\ \text{A}$, $R_g = 3.3\ \Omega$ | t_r | - | 56 | - | ns |
| Turn-Off Delay Time at $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 6\ \text{A}$, $R_g = 3.3\ \Omega$ | $t_{d(off)}$ | - | 18 | - | ns |
| Turn-Off Fall Time at $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 6\ \text{A}$, $R_g = 3.3\ \Omega$ | t_f | - | 8.5 | - | ns |
| Body-Diode PARAMETERS | | | | | |
| Drain-Source Diode Forward Voltage at $I_S = 1\ \text{A}$ | V_{SD} | - | - | 1 | V |
| Body-Diode Continuous Current | I_S | - | - | 6 | A |
| Body Diode Reverse Recovery Time at $I_S = 6\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$ | t_{rr} | - | 8 | - | ns |
| Body Diode Reverse Recovery Charge at $I_S = 6\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$ | Q_{rr} | - | 2.4 | - | nC |



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

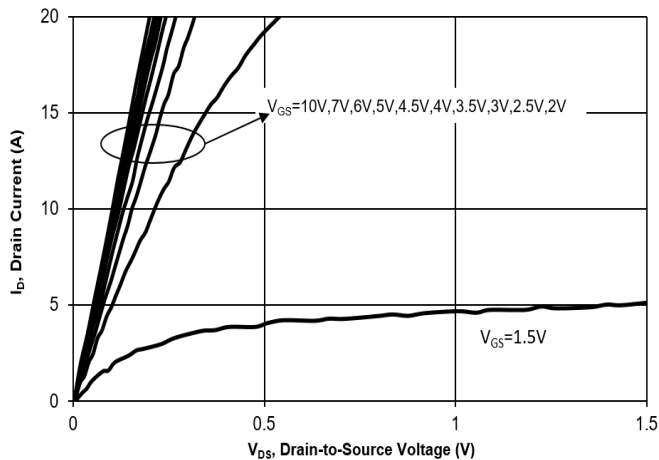


Fig. 2 Typical Transfer Characteristics

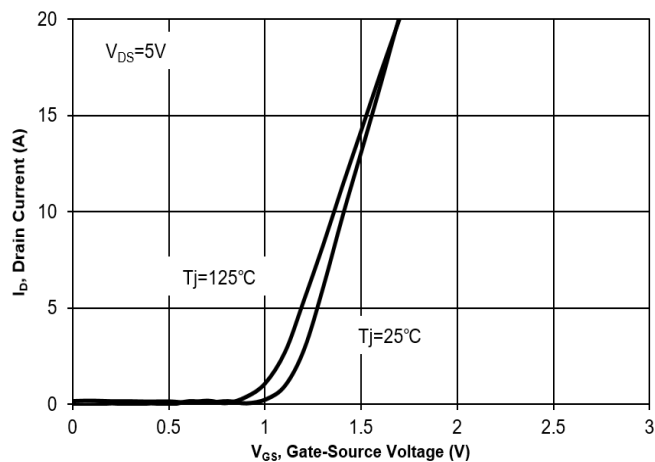


Fig. 3 On-Resistance vs. Drain Current

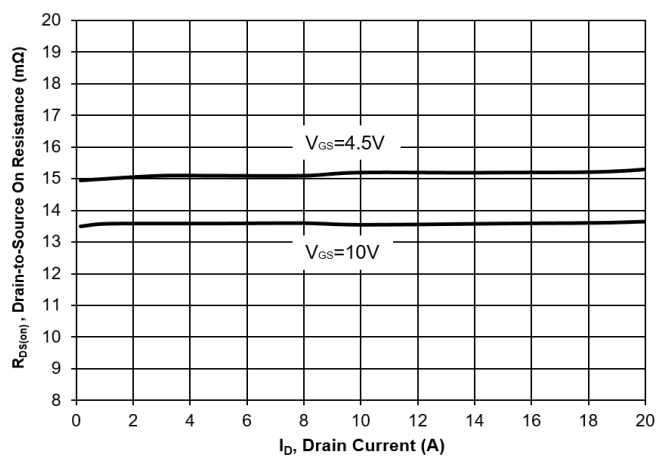


Fig. 4 On-Resistance vs. Gate to Source Voltage

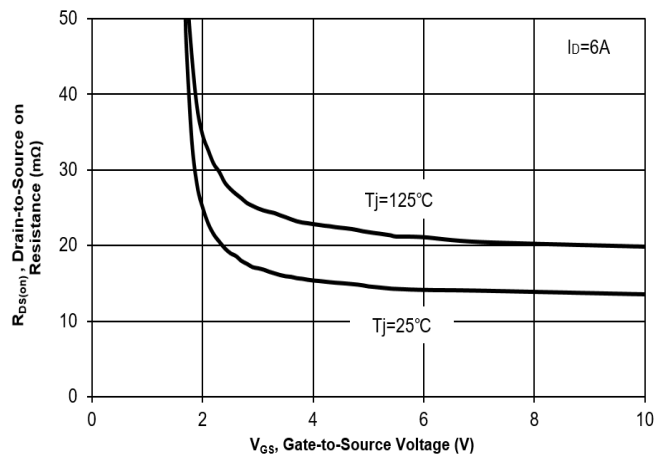


Fig. 5 On-Resistance vs. T_J

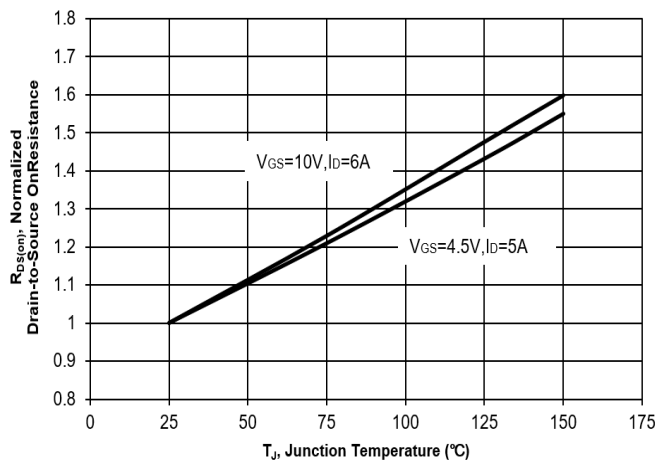
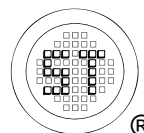
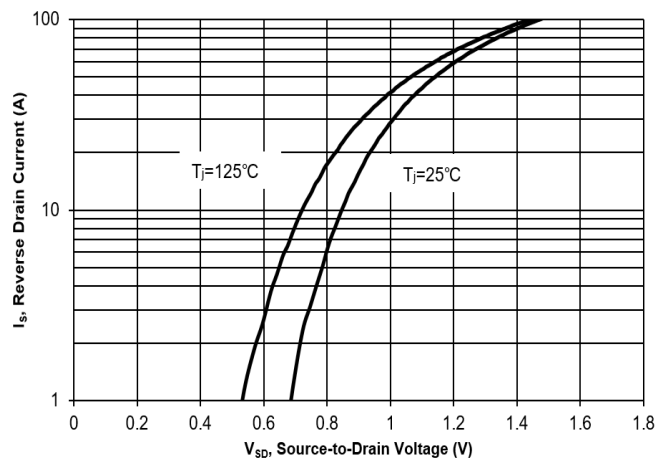


Fig. 6 Typical Body-Diode Forward Characteristics



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

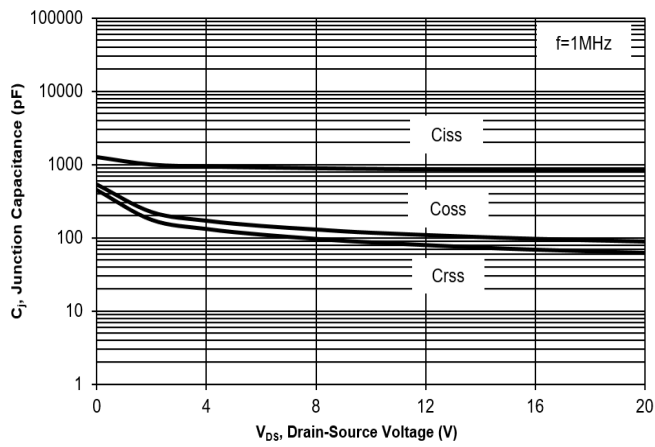


Fig. 8 Drain-Source Leakage Current vs. T_j

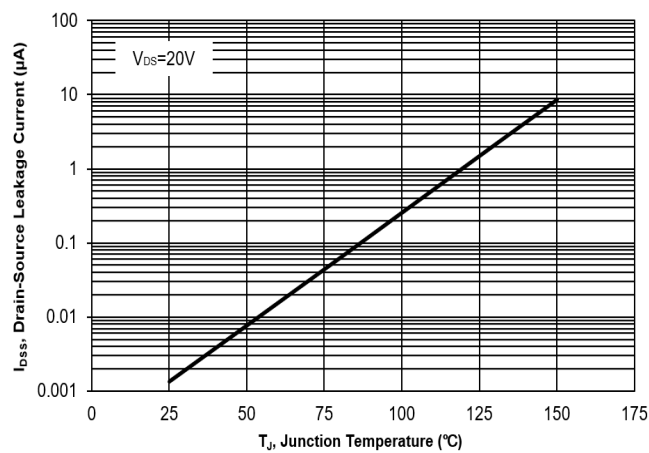


Fig. 9 V_{(BR)DSS} vs. Junction Temperature

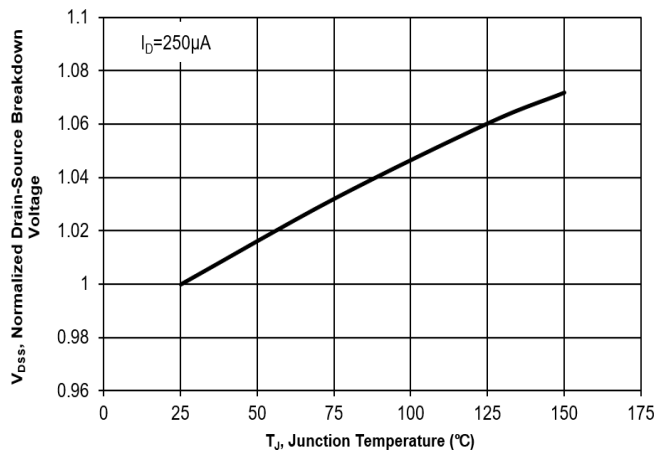


Fig. 10 Gate Threshold Variation vs. T_j

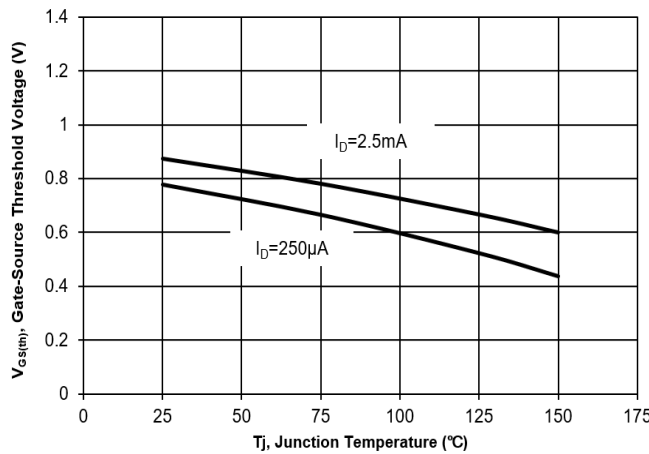
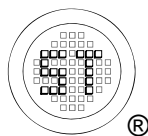
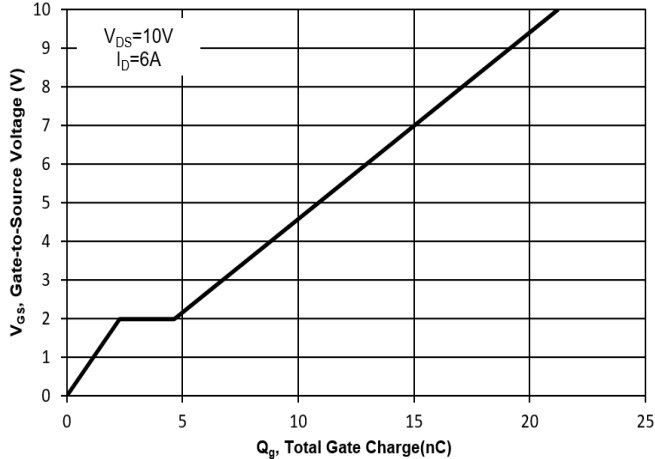


Fig. 11 Gate Charge



Test Circuits

Fig.1-1 Switching times test circuit

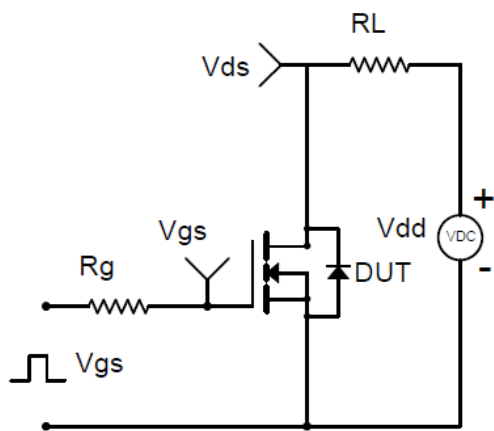


Fig.1-2 Switching Waveform

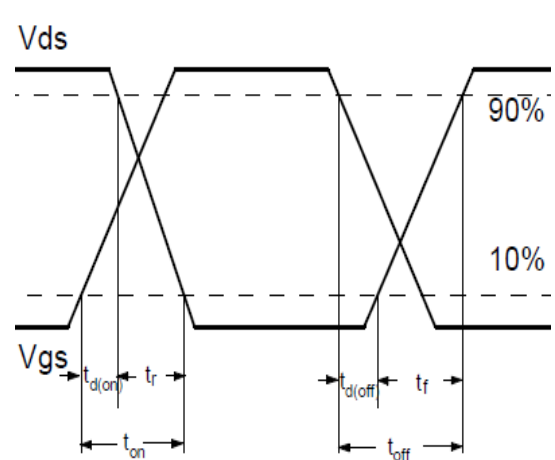


Fig.2-1 Gate charge test circuit

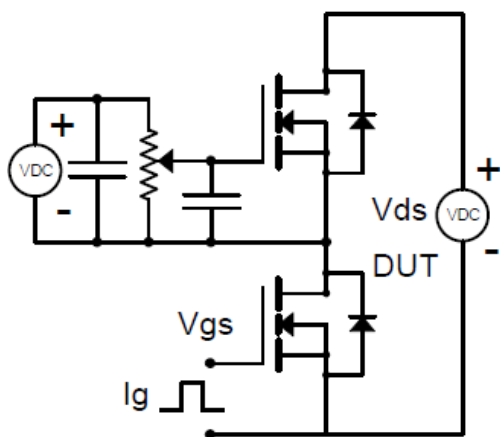
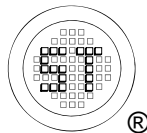
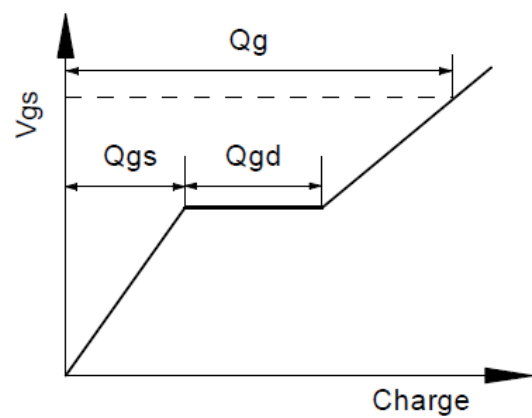


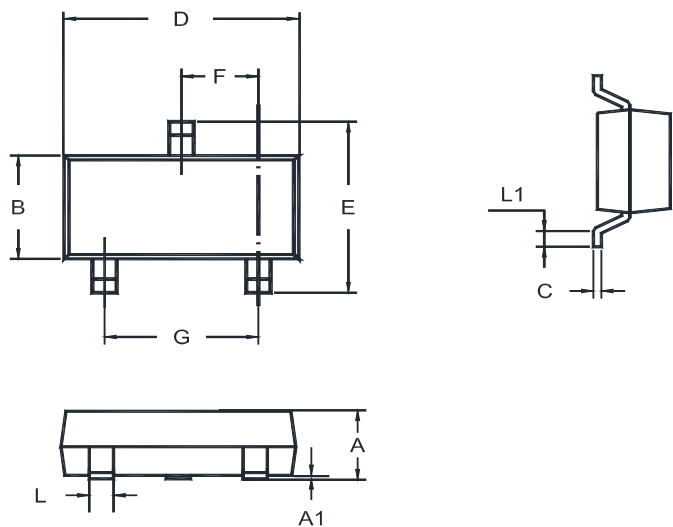
Fig.2-2 Gate charge waveform



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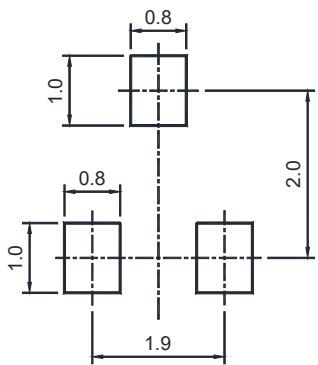
Package Outline (Dimensions in mm)

SOT-23



| Unit | A | A1 | B | C | D | E | F | G | L | L1 |
|------|------|-------|------|------|------|-----|------|------|------|-----|
| mm | 1.20 | 0.100 | 1.40 | 0.19 | 3.04 | 2.6 | 1.02 | 2.04 | 0.51 | 0.2 |
| | 0.89 | 0.013 | 1.20 | 0.08 | 2.80 | 2.2 | 0.89 | 1.78 | 0.37 | MIN |

Recommended Soldering Footprint



Packing information

| Package | Tape Width (mm) | Pitch | | Reel Size | | Per Reel Packing Quantity |
|---------|-----------------|---------|---------------|-----------|------|---------------------------|
| | | mm | inch | mm | inch | |
| SOT-23 | 8 | 4 ± 0.1 | 0.157 ± 0.004 | 178 | 7 | 3,000 |

Marking information

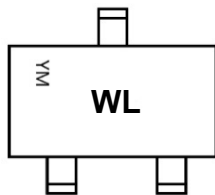
" WL " = Part No.

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial



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